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## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Jens-Christian D. Meiners et al.

Group Art Unit: 1732

Serial No.: 10/672,254

Examiner: A. Ortiz

Filed: September 26, 2003

For: PACKAGING TECHNIQUE FOR ELASTOMERIC MICROFLUIDIC  
CHIPS AND MICROFLUIDIC DEVICE PREPARED THEREBY

Attorney Docket No.: UOM 0275 PUSP

**AMENDMENT UNDER 37 C.F.R. § 1.111**

Mail Stop Amendment  
Commissioner for Patents  
U.S. Patent and Trademark Office  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

In response to the Office Action mailed October 5, 2004, please amend the  
above-identified application as follows:

**CERTIFICATE OF MAILING UNDER 37 C.F.R. § 1.8**

I hereby certify that this paper, including all enclosures referred to herein, is being deposited with the United States Postal Service as first-class mail, postage pre-paid, in an envelope addressed to: Mail Stop Amendment, Commissioner for Patents, U.S. Patent and Trademark Office, P.O. Box 1450, Alexandria, VA 22313-1450 on:

12/15/2004

Date of Deposit

William G. Conger

Name of Person Signing

Signature